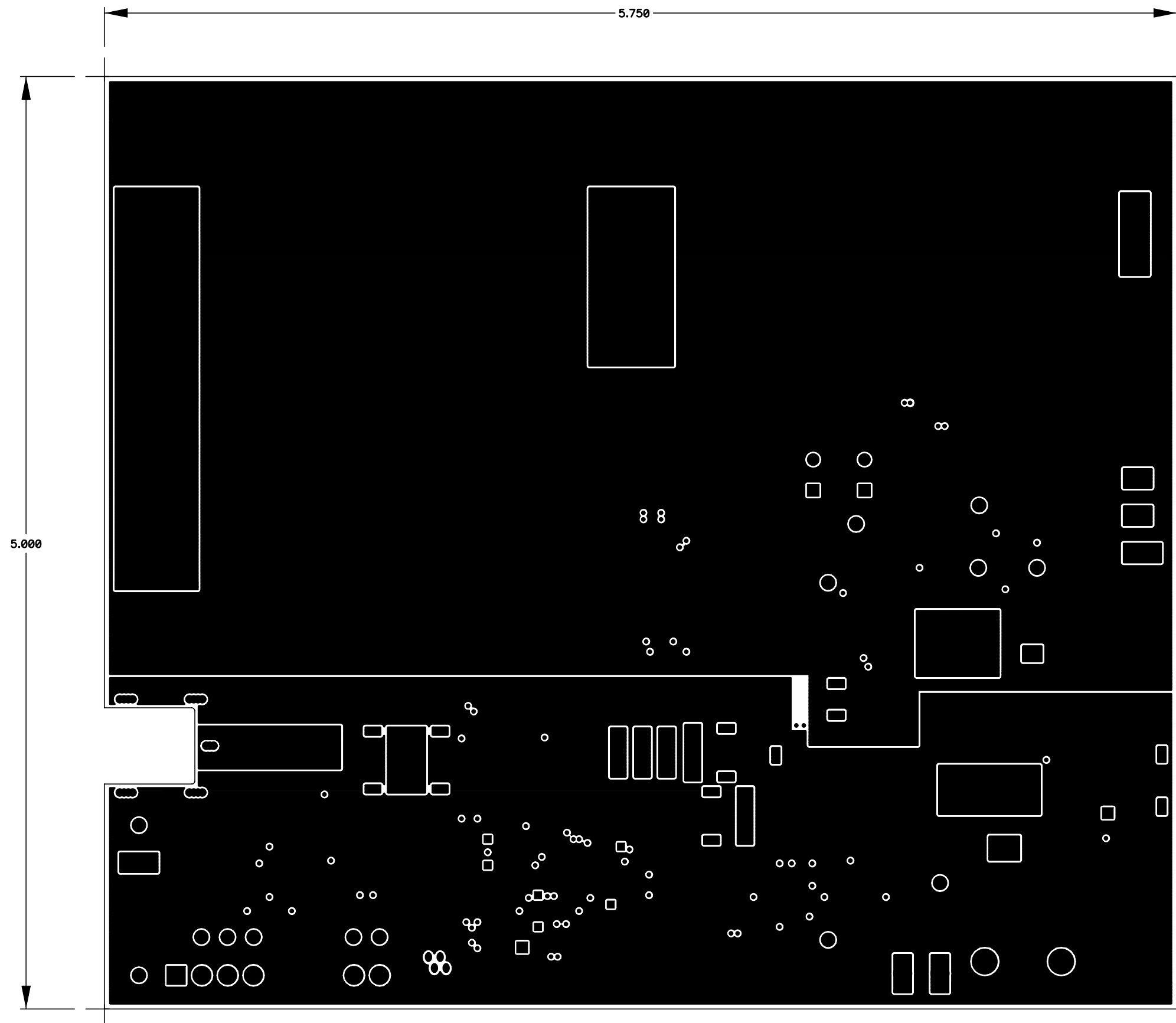
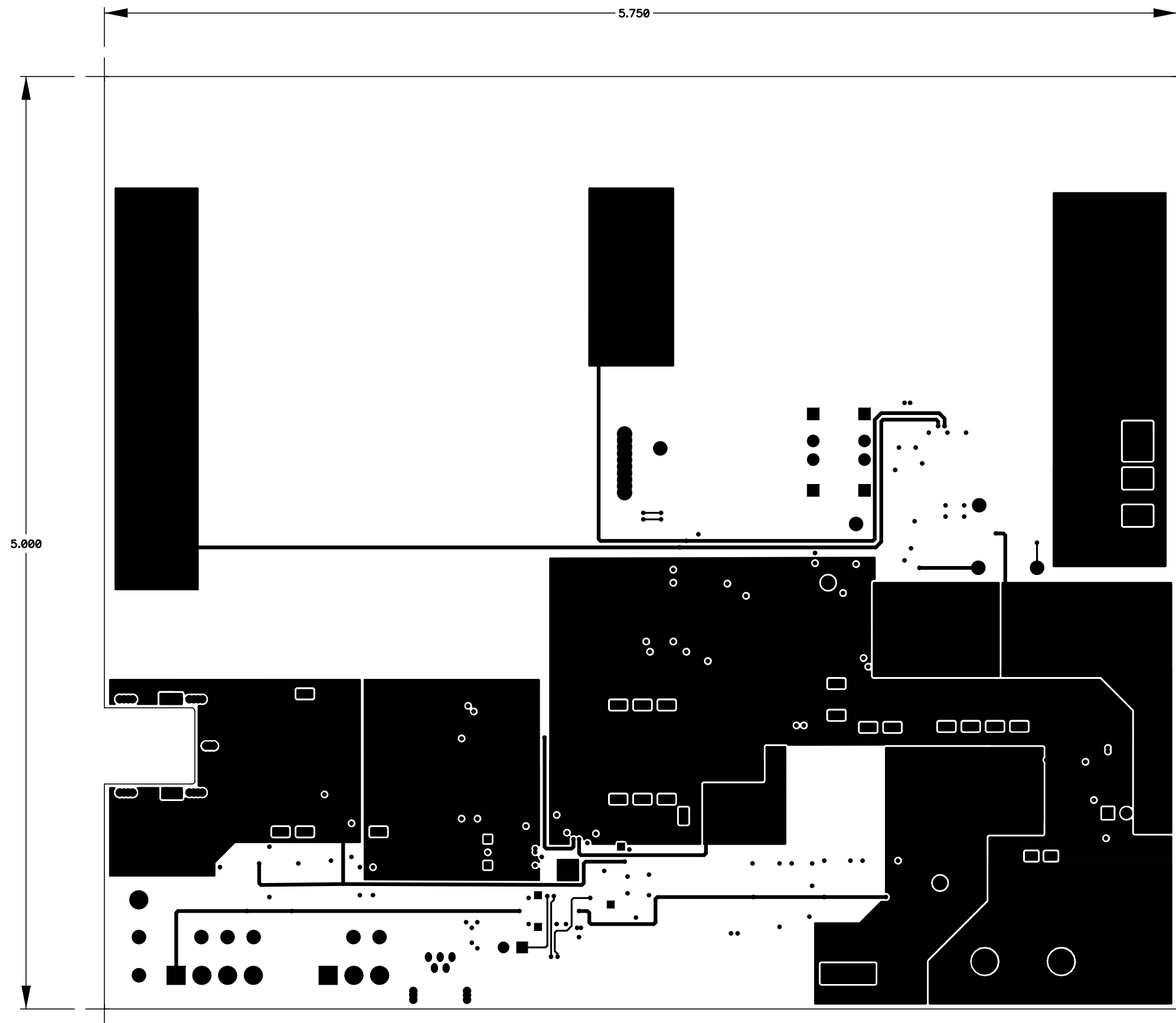


| TEXAS INSTRUMENTS | | Copper Layer Name | | | Silkscreen | | S Mask | | P Mask | | Assembly | | Fab Drawing |
|-----------------------------|-----------------------------------|--------------------------|----------------------------|--|-----------------------------|-----|--------|-----|--------|-----|----------|-----|-------------|
| | | Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot | |
| Board No. PMP5214 | Rev. A | L1 | | | | | | | | | | | |
| Date: 5/10/10 | Filename: PMP5214_revA.PCB | Engineer: Josh M. | PCB Dsgnr: S. McGee | Modified Date: Tue May 18, 2010 | Time Stamp: 15:49:17 | | | | | | | | |



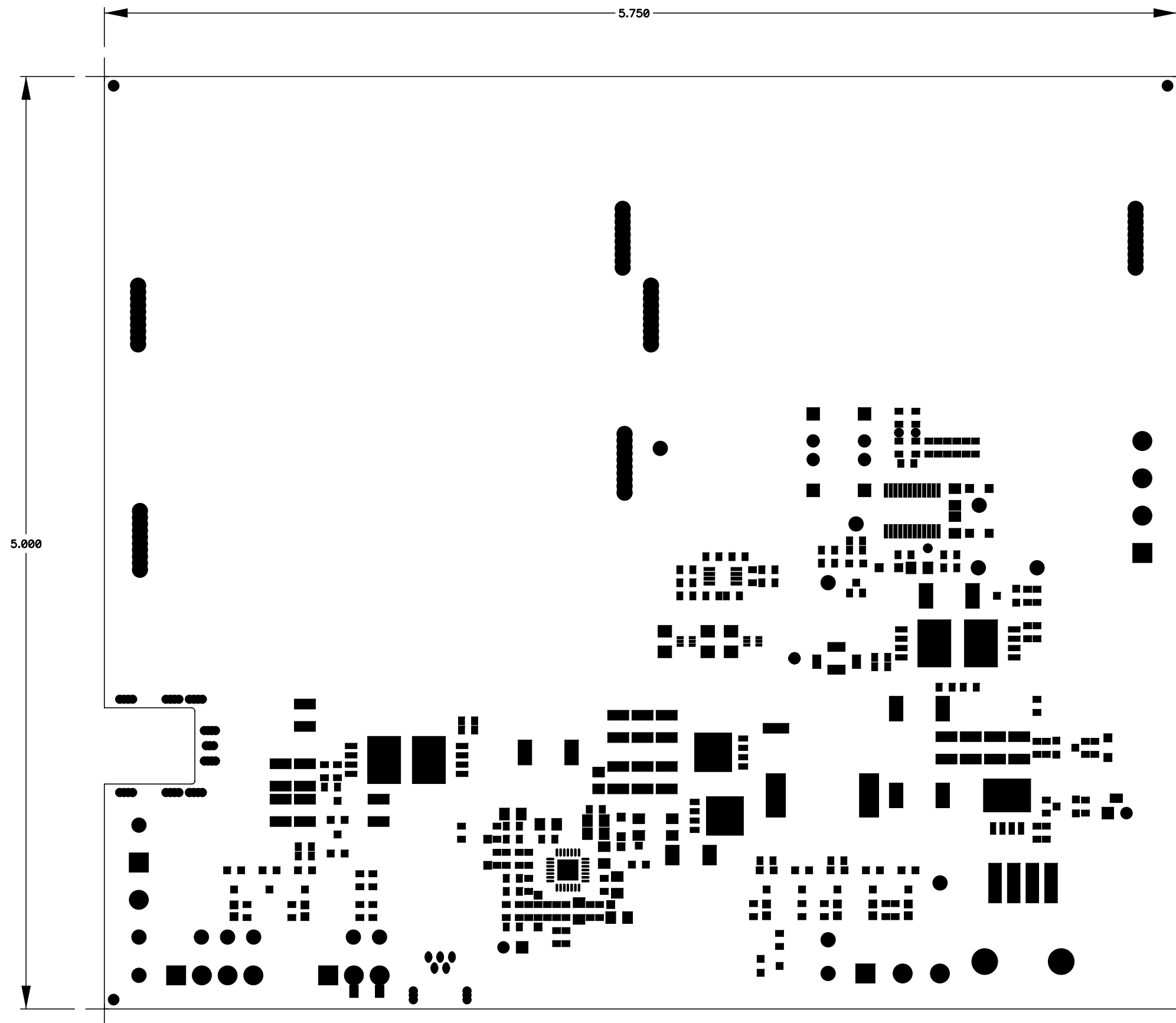
| TEXAS INSTRUMENTS | | | Copper Layer Name | | | Silkscreen | | S Mask | | P Mask | | Assembly | | Fab Drawing |
|----------------------|----------------------------|-------------------|---------------------|---------------------------------|-----|------------|----------------------|--------|-----|--------|-----|----------|-----|-------------|
| | | | Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot | |
| Board No. PMP5214 | Rev. A | | L2 | | | | | | | | | | | |
| Date: 5/10/10 | Filename: PMP5214_revA.PCB | Engineer: Josh M. | PCB Dsgnr: S. McGee | Modified Date: Tue May 18, 2010 | | | Time Stamp: 15:49:17 | | | | | | | |



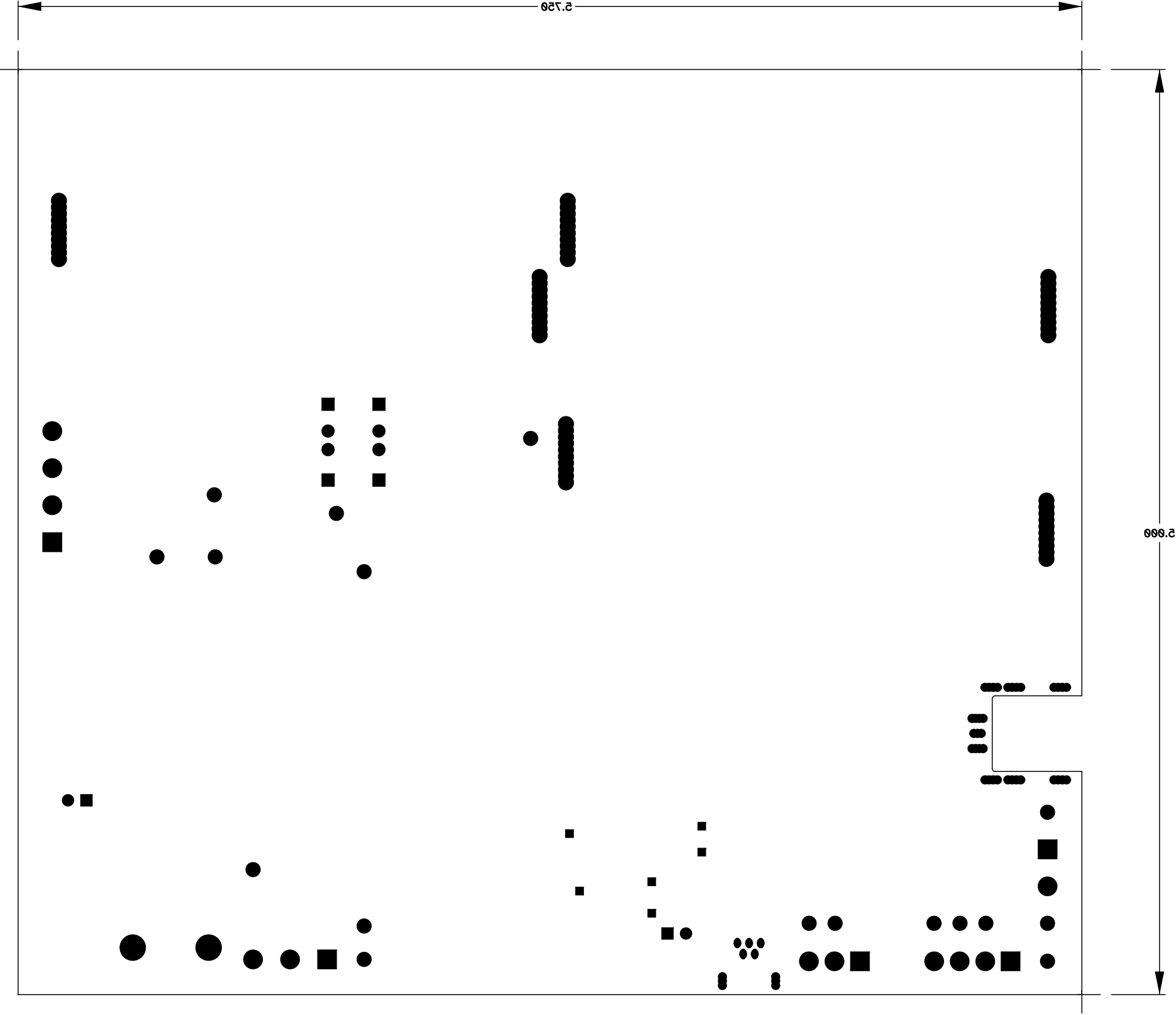
| TEXAS INSTRUMENTS | | Copper Layer Name | | | Silkscreen | | S Mask | | P Mask | | Assembly | | Fab Drawing |
|----------------------|----------------------------|-------------------|---------------------|---------------------------------|----------------------|-----|--------|-----|--------|-----|----------|-----|-------------|
| | | Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot | |
| Board No. PMP5214 | Rev. A | | | L3 | | | | | | | | | |
| Date: 5/10/10 | Filename: PMP5214_revA.PCB | Engineer: Josh M. | PCB Dsgnr: S. McGee | Modified Date: Tue May 18, 2010 | Time Stamp: 15:49:17 | | | | | | | | |



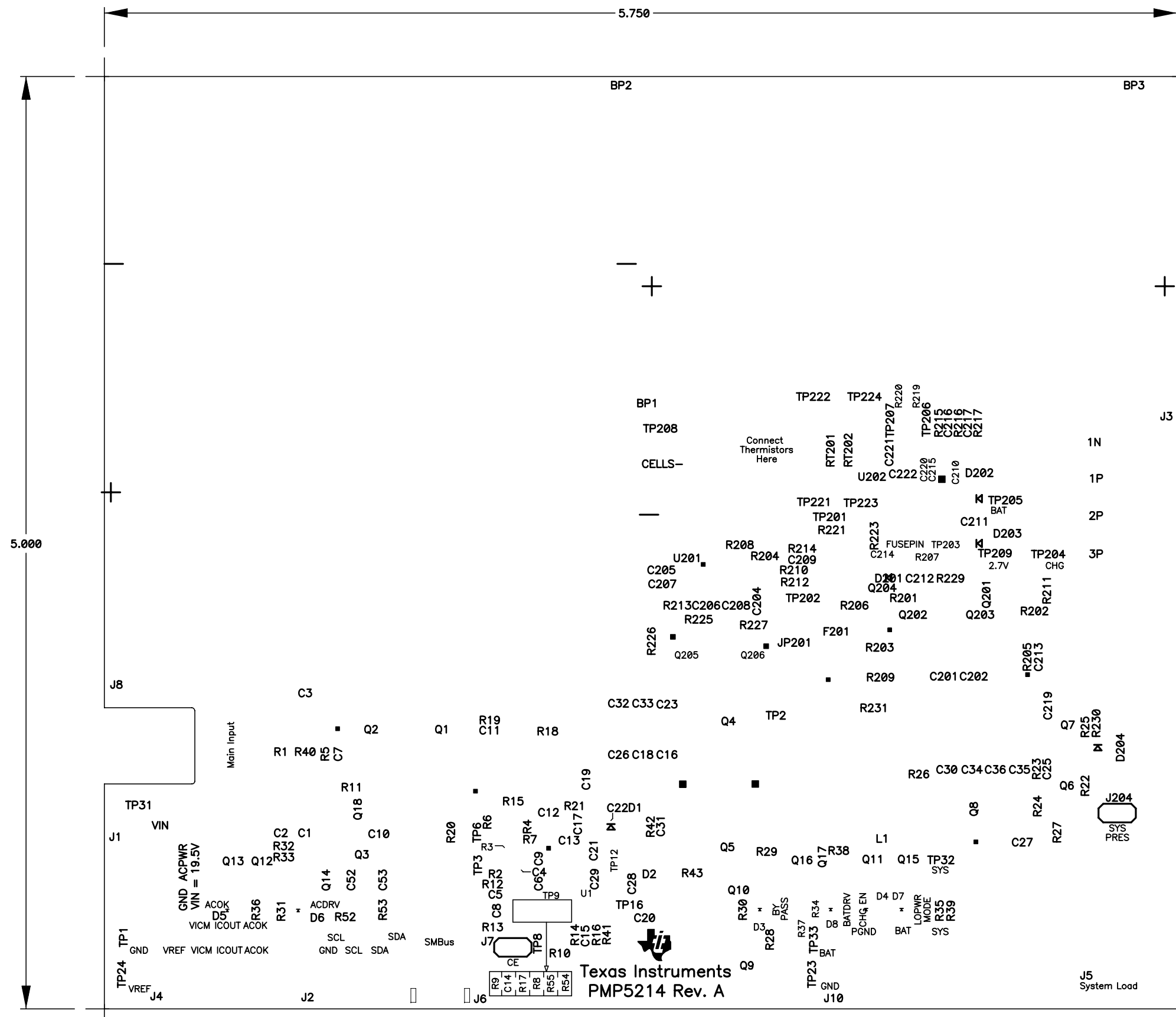
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|-------------------|----------|----------------------------|-----|---------------------|-----|---------------------------------|-----|----------------------|-----|
| Date: 5/10/10 | | Filename: PMP5214_rev1.PCB | | PCB Dsgnr: S. McGee | | Modified Date: Tue May 18, 2010 | | Time Stamp: 12:49:17 | |
| Board No. PMP5214 | | Rev. A | | Copper Layer Name | | Silkscreen | | P Mask | |
| Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top |
| Top | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot |
| Assembly | | Fop Drawing | | | | | | | |



| TEXAS INSTRUMENTS | | Copper Layer Name | | | Silkscreen | | S Mask | | P Mask | | Assembly | | Fab Drawing |
|----------------------|----------------------------|-------------------|---------------------|---------------------------------|----------------------|-----|--------|-----|--------|-----|----------|-----|-------------|
| | | Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot | |
| Board No. PMP5214 | Rev. A | | | | | | M1 | | | | | | |
| Date: 5/10/10 | Filename: PMP5214_revA.PCB | Engineer: Josh M. | PCB Dsgnr: S. McGee | Modified Date: Tue May 18, 2010 | Time Stamp: 15:49:17 | | | | | | | | |



| | | | | | | | | | |
|-------------------|----------|---------------------------|-----|----------------------|-----|---------------------------------|-----|----------------------|-----|
| Date: 5/10/10 | | Filename: PMP5214_rev.PCB | | PCB Design: S. McGee | | Modified Date: Tue May 18, 2010 | | Time Stamp: 12:49:17 | |
| Board No. PMP5214 | | Rev. A | | Copper Layer Name | | Silkscreen | | P Mask | |
| Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top |
| Assembly | | P Mask | | 2 Mask | | Silkscreen | | Top Drawing | |
| Top | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot |



| TEXAS INSTRUMENTS | | Copper Layer Name | | | Silkscreen | | S Mask | | P Mask | | Assembly | | Fab Drawing |
|-------------------|---------|-------------------|------------------|-----------|------------|------------|----------|----------------|------------------|-----|----------|-------------|-------------|
| | | Top | Internal | Bot | Top | Bot | Top | Bot | Top | Bot | Top | Bot | |
| Board No. | PMP5214 | Rev. | A | | | | S1 | | | | | | |
| Date: | 5/10/10 | Filename: | PMP5214_revA.PCB | Engineer: | Josh M. | PCB Dsgnr: | S. McGee | Modified Date: | Tue May 18, 2010 | | | Time Stamp: | 15:49:17 |

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